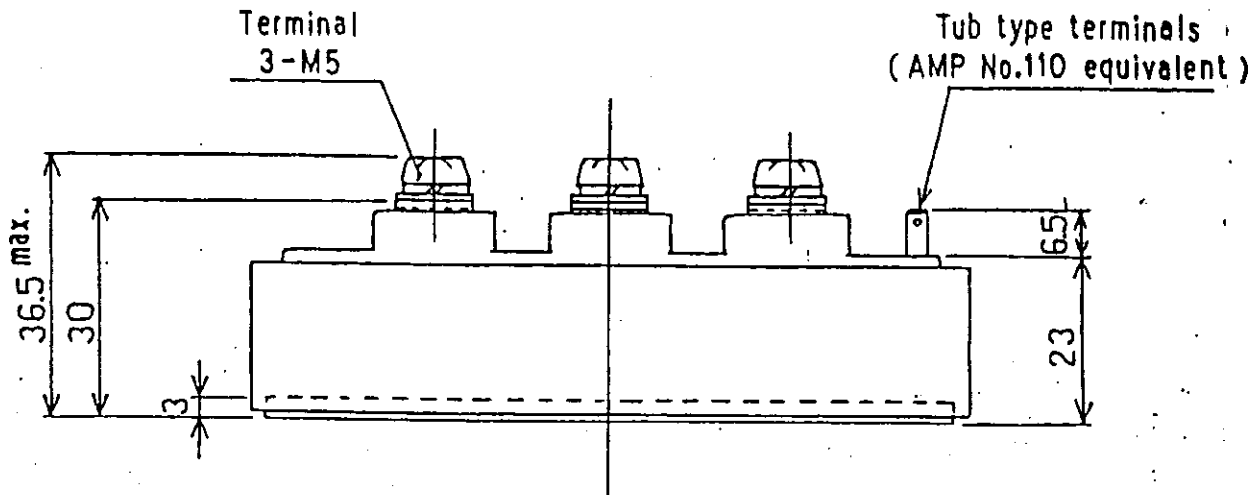
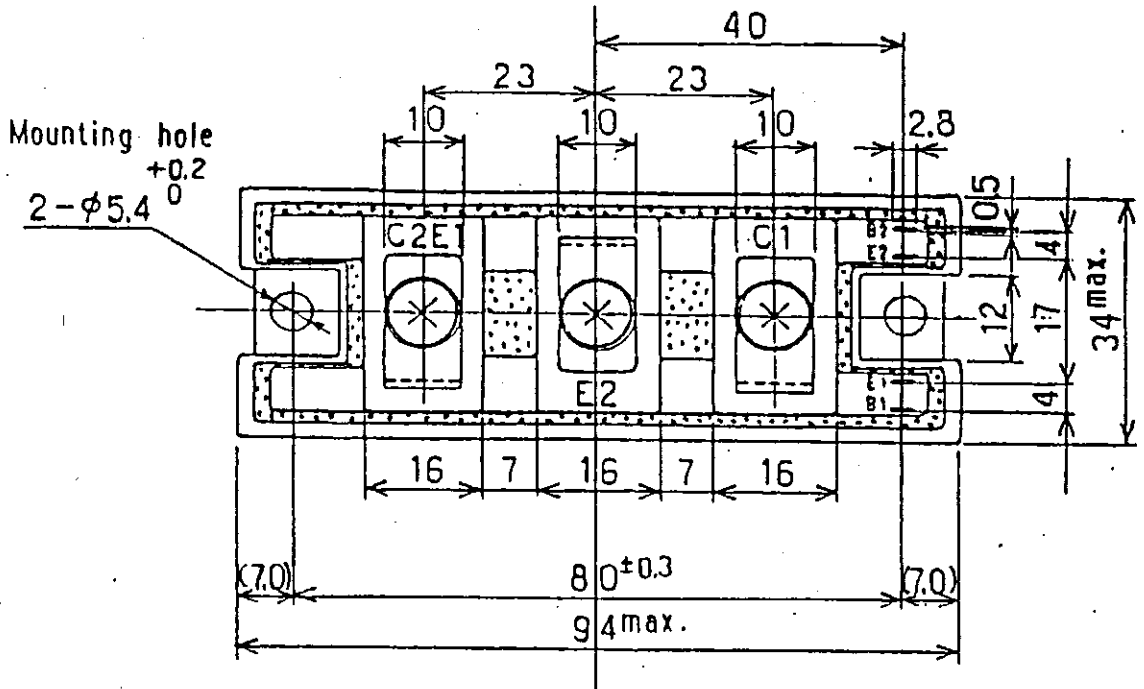


2 D I 5 0 Z - 1 4 0 (TENTATIVE)

1. Outline Drawing

Unit : mm

*Isolation Voltage : AC 2500 V 1 minute

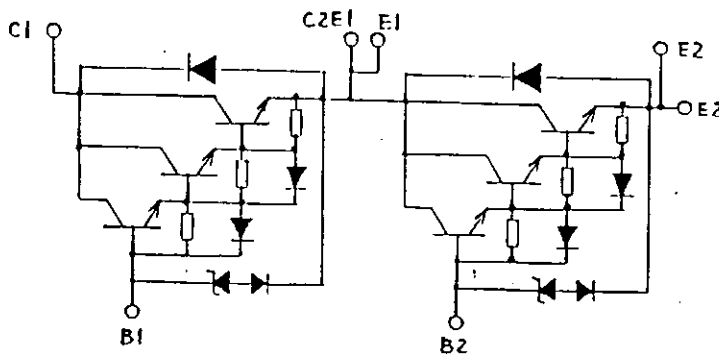


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2. Equivalent Circuit



3. Absolute Maximum Ratings (TC=25°C)

Item		Symbol	Maximum Ratings	Unit
Collector-Base Voltage		VCBO	1 4 0 0	V
Collector-Emitter Voltage		VCEO	1 4 0 0	V
Emitter-Base Voltage		VEBO	1 0	V
Collector Current	DC	IC	5 0	A
	1ms	ICP	1 0 0	A
	DC	-IC	5 0	A
Base Current	DC	IB	3	A
	1ms	IBP	6	A
Collector Power Dissipation	One Transistor	PC	4 0 0	W
	Two Transistor		8 0 0	W
Operating Temperature		Tj	+ 1 5 0	°C
Storage Temperature		Tstg	- 4 0 ~ + 1 2 5	°C
Screw Torque	Mounting *1		3 5	kg · cm
	Terminals *1		3 5	
Isolation Voltage		A C 2 5 0 0		V

Note :

*1 Recommendable Value : 25 ~ 35 kg · cm (M5)

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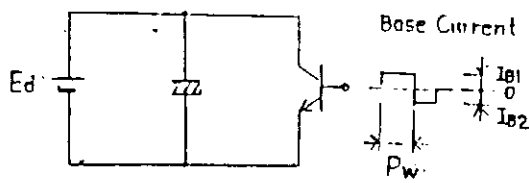
4. Electrical Characteristics (Tj=25°C unless otherwise specified)

Characteristics	Symbol	Conditions	MIN	MAX	Unit
Collector-Base Voltage	VCBO	ICBO=10mA	1400		V
Collector-Emitter Voltage	VCEO	ICEO=10mA	1400		
Collector-Emitter Voltage	VCEX(SUS)	VBE = -3V	1200		
Emitter-Base Voltage	VEBO	IEBO=200mA	10		
Collector Cutoff Current	ICBO	VCBO=1400V		10	mA
Emitter Cutoff Current	IEBO	VEBO=10V		200	
DC Current Gain	hFE	IC=50A VCE=2.8V Tj=125 °C	75		
		IC=50A VCE= 5V	100		
Collector Saturation Voltage	VCE(sat)	IC=50A		2.8	V
Base Saturation Voltage	VBE(sat)	IB=0.7A		3.5	
Switching Time	ton	IC=50A		3.0	μs
	tstg	IB1 =+0.7A		15.0	
	tf	IB2 =-1.0A		2.0	
Emitter-Collector Voltage	VECO	IECO=50A		2.0	V
Reverse Recovery Time	trr	IF=50A		0.8	μs
Short Circuit Capability *2	Ed	IB1 =+0.7A IB2 =-1.0A	PW=50μs	750	V

5. Thermal Characteristics

Characteristics	Symbol	Conditions	MIN	MAX	Unit
Thermal Resistance	Rth(j-c)	Power Transistor		0.31	°C/W
		Fast Recovery Diode		1.2	
Contact Thermal Resistance	Rth(c-f)	Mounting torque 35kg·cm with thermal compound	(TYP) 0.06		

*2 Test Circuit



Wiring Length

Collector : ≤ 10 cm

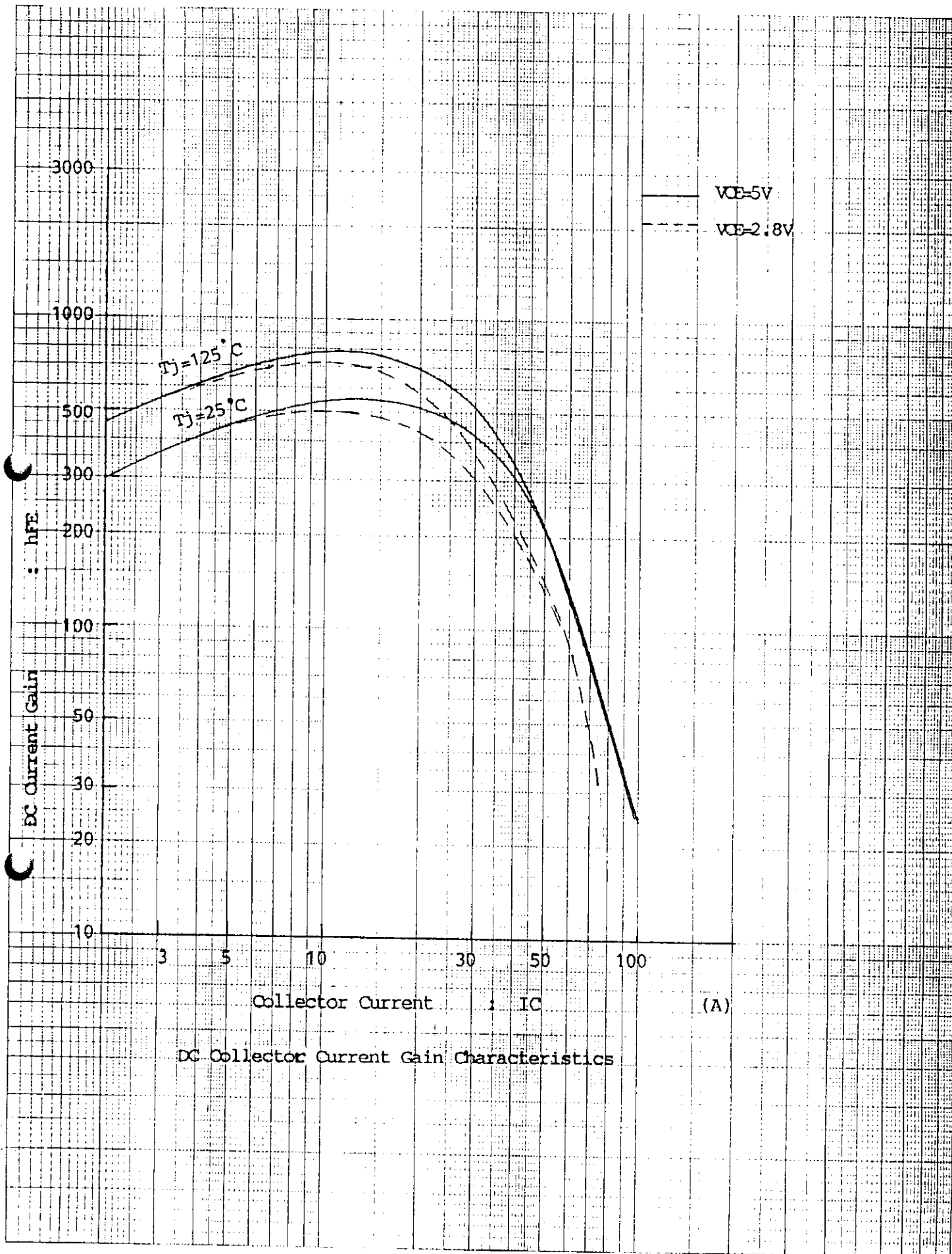
Emitter : ≤ 10 cm

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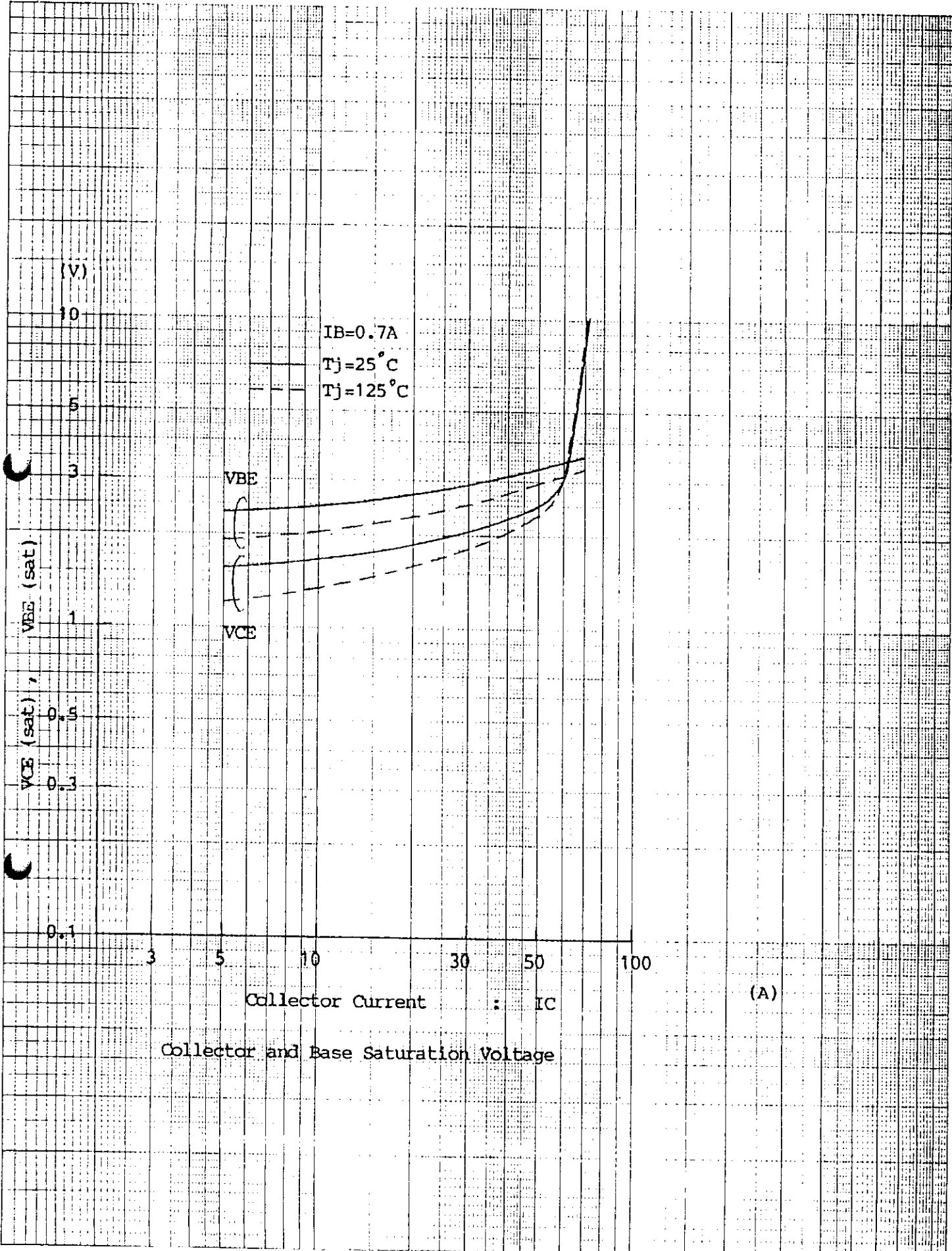
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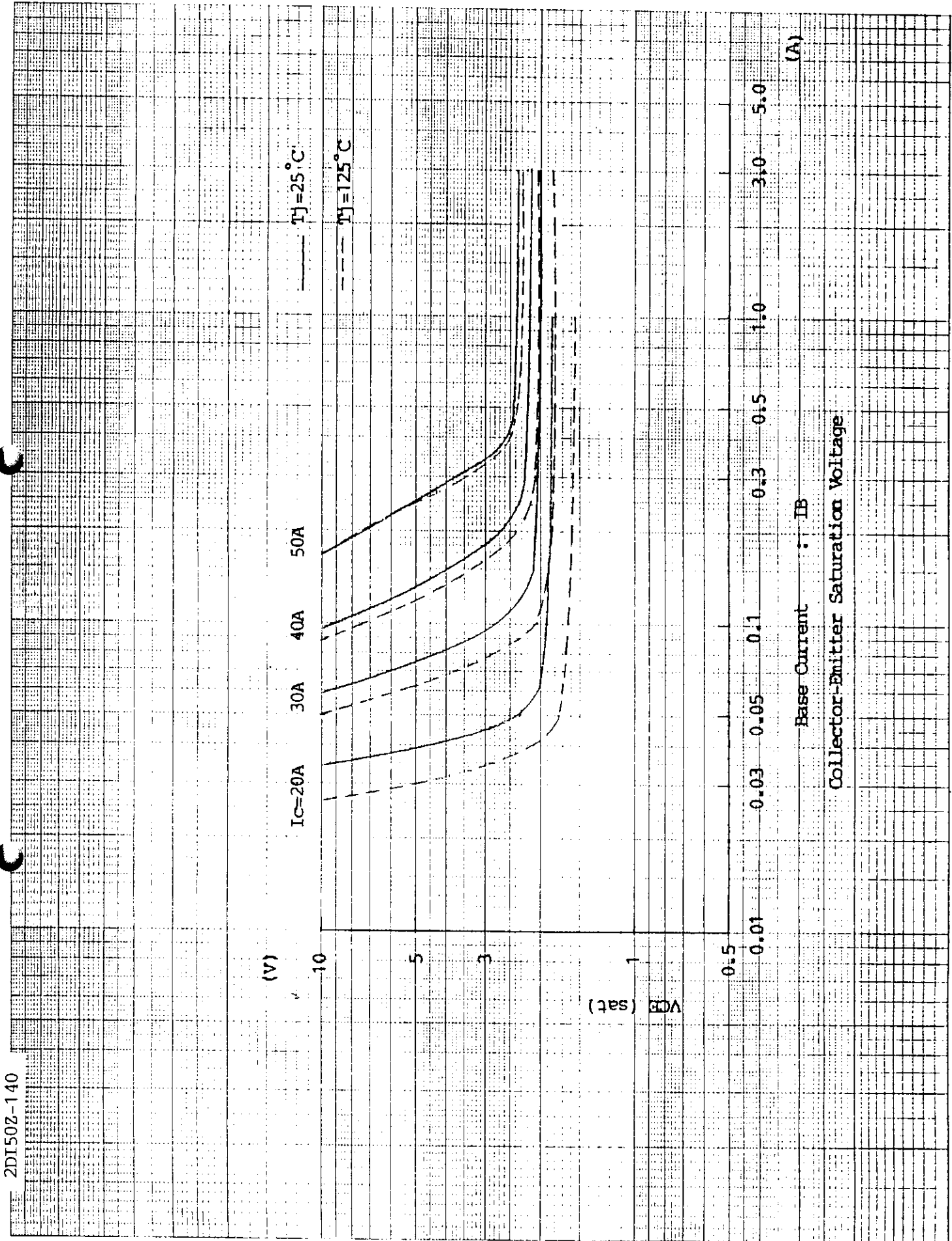


DC Collector Current Gain Characteristics



Collector Current : I_C (A)

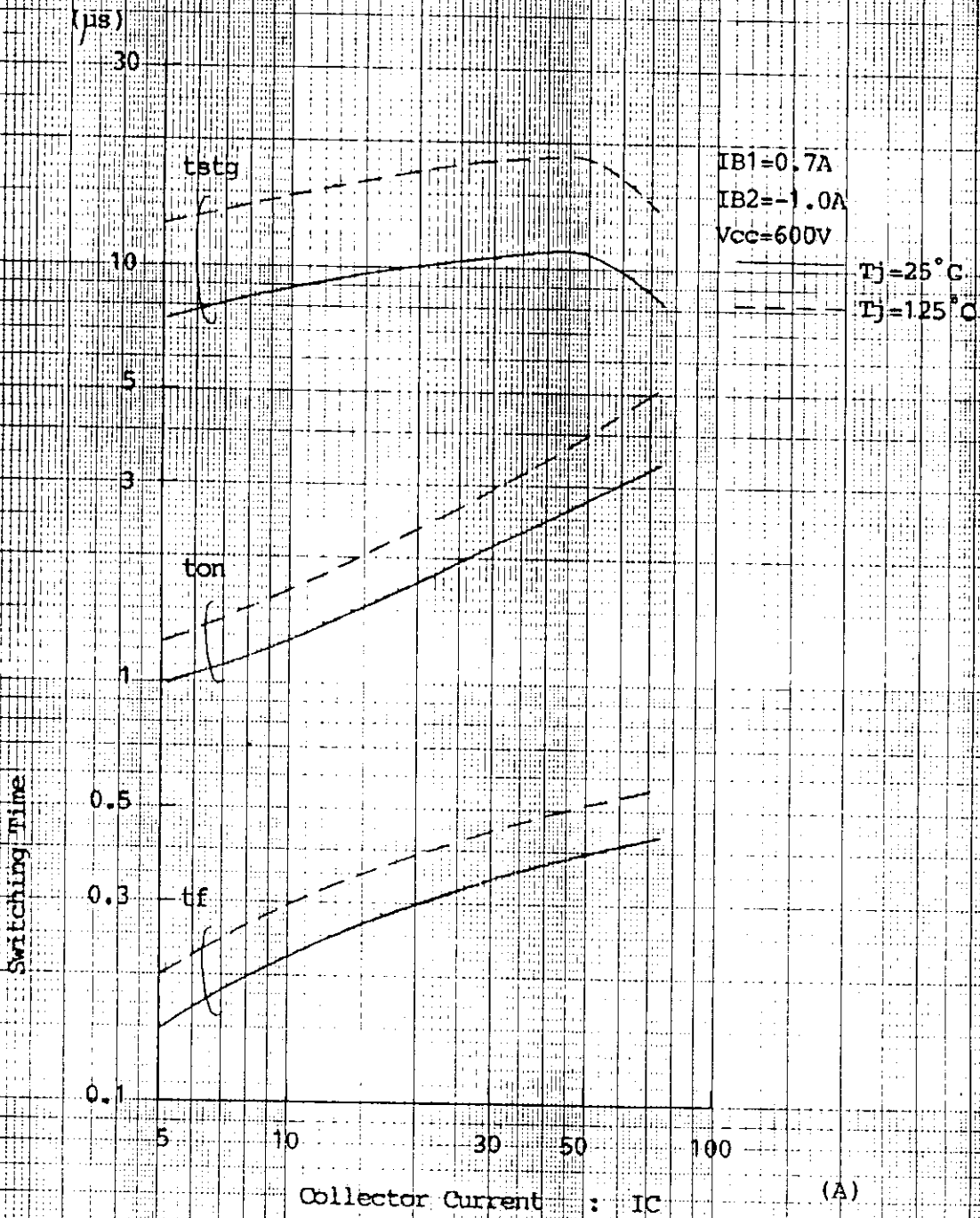
Collector and Base Saturation Voltage



(A)

Base Current : I_B

Collector-Emitter Saturation Voltage



(μ s)

50

30

10

5

3

1

0.5

0.3

0.1

Turn-Off Time
 t_{stg} , t_f

$I_C=50A$
 $I_{B1}=0.7A$
 $V_{CC}=600V$

— $T_J=25^\circ C$

- - - $T_J=125^\circ C$

t_{stg}

t_f

0.5 1.0 3.0 5.0 10.0

Reverse Base Current : $-I_{B2}$

(A)

$-I_{B2}$ vs Turn off Time Characteristics

2DI50Z-140

Reverse Biased Safe Operating Area

(A)

100

I_C

Collector Current

50

0

$I_{B2} = -1A$

$T_j = 25^\circ C$

0

200

400

600

800

1000

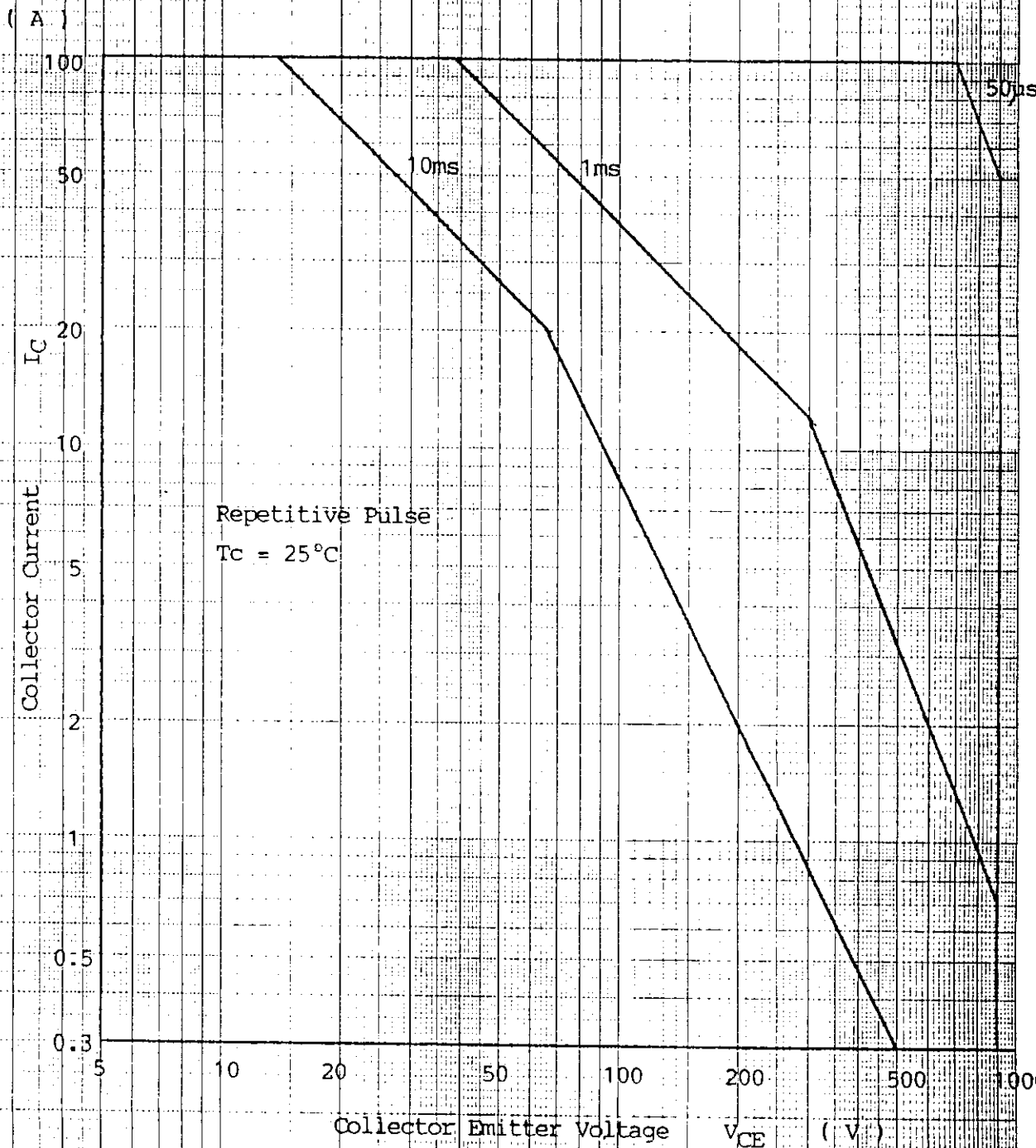
1200

1400

Collector-Emitter Voltage V_{CEX} (V)

MS5M1273

Forward Bias Safe Operating Area



2DI50Z-140

Transient Thermal Resistance (Transistor)

(°C/W)

0.5

Rth(j-c)

0.05

0.01

0.005

1x10⁻⁴

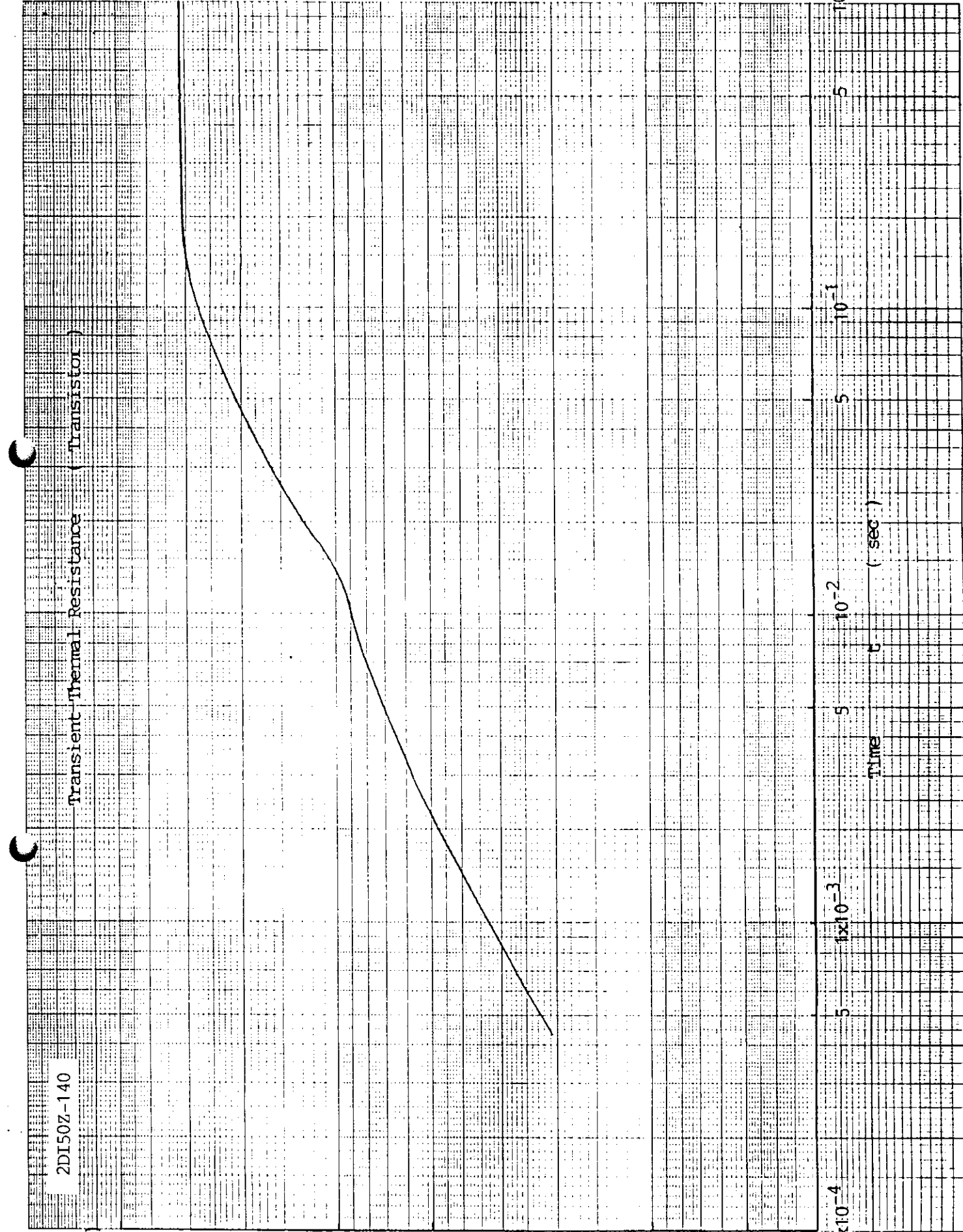
5 1x10⁻³

5 10⁻²

5 10⁻¹

100

Time (sec)



2DI50Z-140

Transient Thermal Resistance (F.R.D.)

(°C/W)

5

Rth(j-c)

1

0.5

Thermal Resistance

0.1

0.05

1x10⁻⁴

5

1x10⁻³

5

1x10⁻²

5

1x10⁻¹

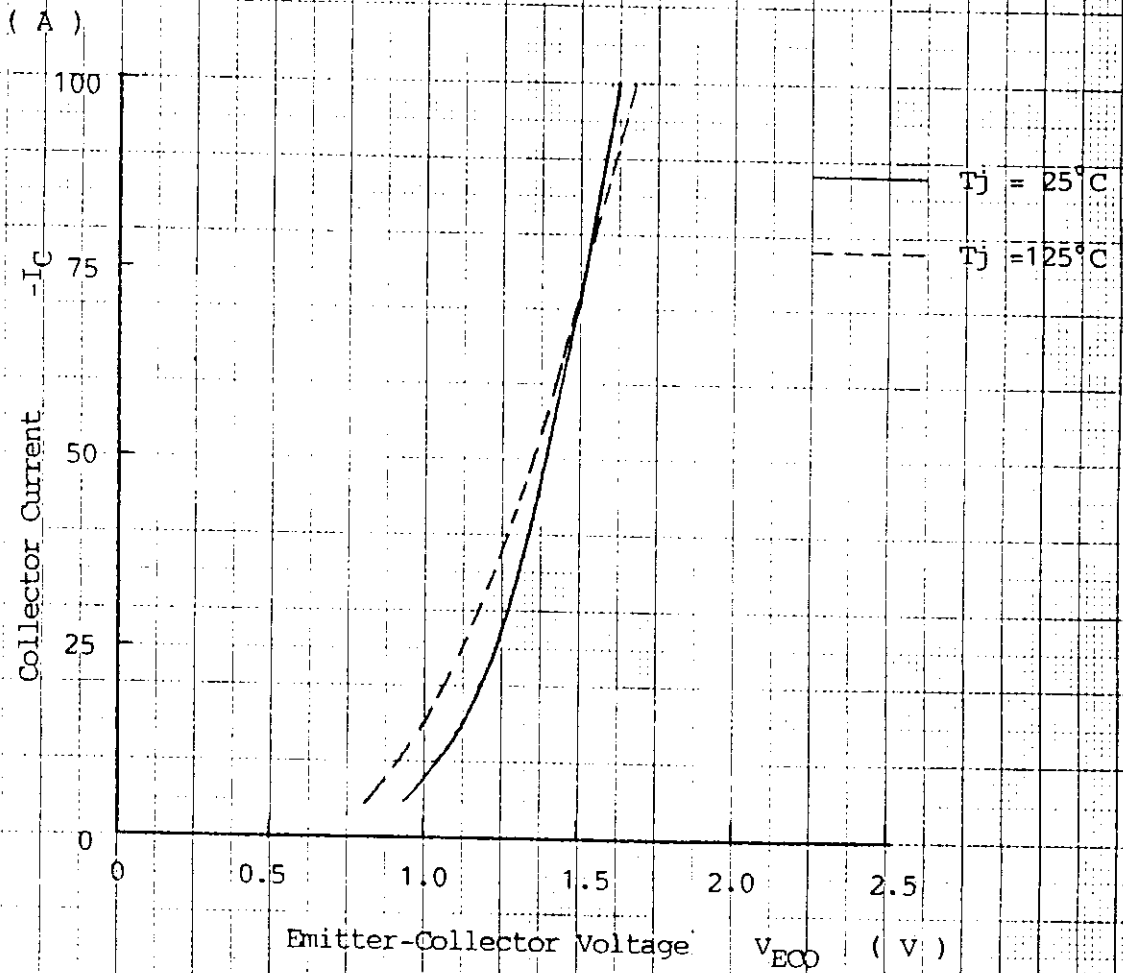
5

1x10⁰

Time

t

(sec)



Forward Characteristics of Build-in Fast Recovery Diode

Power Derating Factor

